

54F/74F398 • 54F/74F399 Quad 2-Port Register

General Description

The 'F398 and 'F399 are the logical equivalents of a quad 2-input multiplexer feeding into four edge-triggered flip-flops. A common Select input determines which of the two 4-bit words is accepted. The selected data enters the flip-flops on the rising edge of the clock. The 'F399 is the 16-pin version of the 'F398, with only the Q outputs of the flip-flops available.

Features

- Select inputs from two data sources
- Fully positive edge-triggered operation
- Both true and complement outputs—'F398
- Guaranteed 4000V minimum ESD protection—'F399

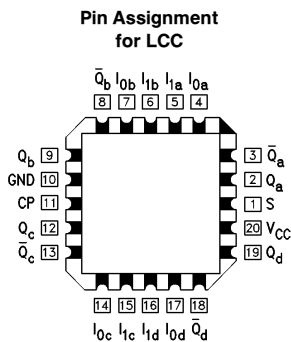
| Commercial | Military | Package Number | Package Description |
|-------------------|-------------------|----------------|---|
| 74F398PC | | N20A | 20-Lead (0.300" Wide) Molded Dual-In-Line |
| | 54F398DM (Note 2) | J20A | 20-Lead Ceramic Dual-In-Line |
| 74F398SC (Note 1) | | M20B | 20-Lead (0.300" Wide) Molded Small Outline, JEDEC |
| | 54F398FM (Note 2) | W20A | 20-Lead Cerpack |
| | 54F398LM (Note 2) | E20A | 20-Lead Ceramic Leadless Chip Carrier, Type C |
| 74F399PC | | N20A | 20-Lead (0.300" Wide) Molded Dual-In-Line |
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| 74F399SC (Note 1) | | M20B | 20-Lead (0.300" Wide) Molded Small Outline, JEDEC |
| 74F399SJ (Note 1) | | M20D | 20-Lead (0.300" Wide) Molded Small Outline, EIAJ |
| | 54F399FM (Note 2) | W20A | 20-Lead Cerpack |
| | 54F399LM (Note 2) | E20A | 20-Lead Ceramic Leadless Chip Carrier, Type C |

Note 1: Devices also available in 13" reel. Use suffix = SCX and SJX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMOB, FMOB and LMOB.

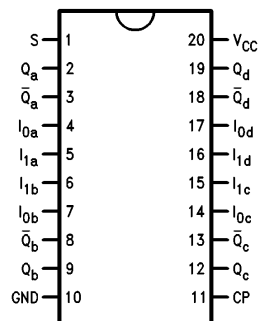
Connection Diagrams

'F398



TL/F/9533-5

Pin Assignment for DIP, SOIC and Flatpak

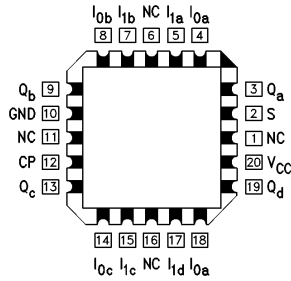


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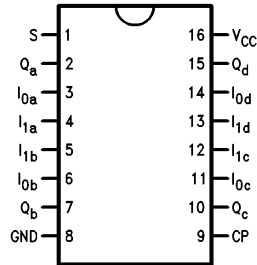
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Connection Diagrams (Continued)

'F399

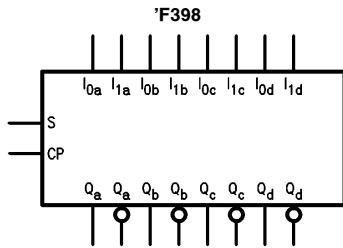


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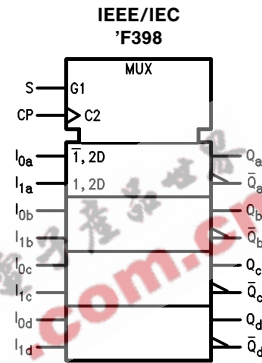


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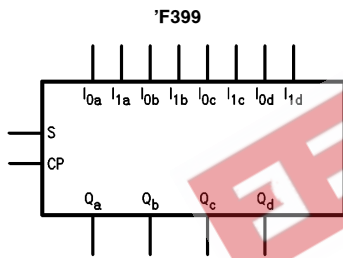
Logic Symbols



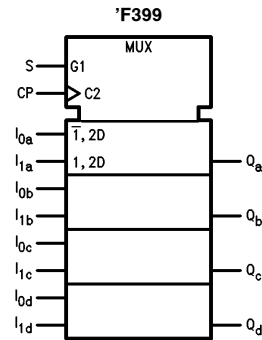
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TL/F/9533-1



TL/F/9533-4



TL/F/9533-3

Unit Loading/Fan Out

| Pin Names | Description | 54F/74F | |
|---------------------------|--|------------------|---|
| | | U.L. HIGH/LOW | Input I_{IH}/I_{IL} Output I_{OH}/I_{OL} |
| S | Common Select Input | 1.0/1.0 | 20 μ A/ -0.6 mA |
| CP | Clock Pulse Input (Active Rising Edge) | 1.0/1.0 | 20 μ A/ -0.6 mA |
| I_{0a} - I_{0d} | Data Inputs from Source 0 | 1.0/1.0 | 20 μ A/ -0.6 mA |
| I_{1a} - I_{1d} | Data Inputs from Source 1 | 1.0/1.0 | 20 μ A/ -0.6 mA |
| Q_a - Q_d | Register True Outputs | 50/33.3 | -1 mA/20 mA |
| \bar{Q}_a - \bar{Q}_d | Register Complementary Outputs ('F398) | 50/33.3 | -1 mA/20 mA |

Functional Description

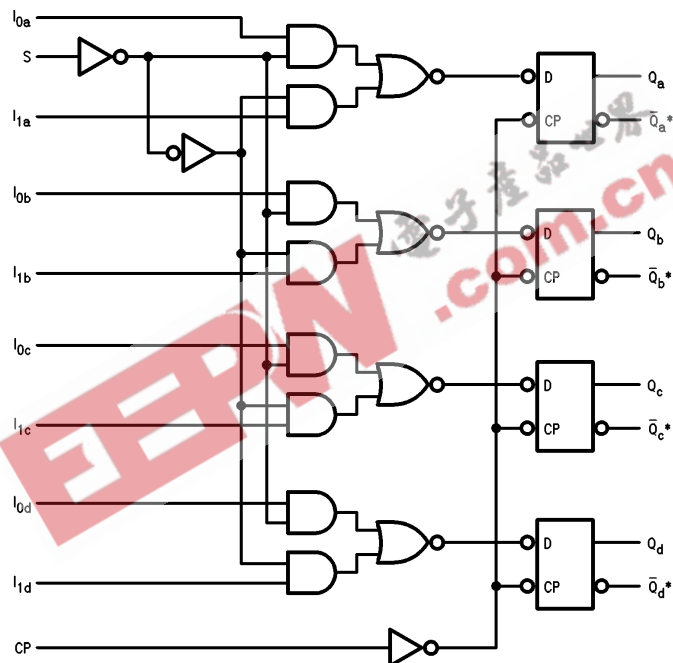
The 'F398 and 'F399 are high-speed quad 2-port registers. They select four bits of data from either of two sources (Ports) under control of a common Select input (S). The selected data is transferred to a 4-bit output register synchronous with the LOW-to-HIGH transition of the Clock input (CP). The 4-bit D-type output register is fully edge-triggered. The Data inputs (I_{0x}, I_{1x}) and Select input (S) must be stable only a setup time prior to and hold time after the LOW-to-HIGH transition of the Clock input for predictable operation. The 'F398 has both Q and \bar{Q} outputs.

Function Table

| S | Inputs | | Outputs | |
|---|--------|-------|---------|-------------|
| | I_0 | I_1 | Q | \bar{Q}^* |
| l | l | X | L | H |
| l | h | X | H | L |
| h | X | l | L | H |
| h | X | h | H | L |

H = HIGH Voltage Level
 L = LOW Voltage Level
 h = HIGH Voltage Level one setup time prior to the LOW-to-HIGH clock transition
 l = LOW Voltage Level one setup time prior to the LOW-to-HIGH clock transition
 X = Immaterial
 *F398 only

Logic Diagram



**F398 Only

Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

| | |
|---|--------------------------|
| Storage Temperature | -65°C to +150°C |
| Ambient Temperature under Bias | -55°C to +125°C |
| Junction Temperature under Bias | -55°C to +175°C |
| Plastic | -55°C to +150°C |
| V _{CC} Pin Potential to Ground Pin | -0.5V to +7.0V |
| Input Voltage (Note 2) | -0.5V to +7.0V |
| Input Current (Note 2) | -30 mA to +5.0 mA |
| Voltage Applied to Output in HIGH State (with V _{CC} = 0V) | |
| Standard Output | -0.5V to V _{CC} |
| TRI-STATE® Output | -0.5V to +5.5V |

Current Applied to Output in LOW State (Max) twice the rated I_{OL} (mA)

ESD Last Passing Voltage (Min)—F399 4000V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

Recommended Operating Conditions

| | |
|------------------------------|-----------------|
| Free Air Ambient Temperature | |
| Military | -55°C to +125°C |
| Commercial | 0°C to +70°C |
| Supply Voltage | |
| Military | +4.5V to +5.5V |
| Commercial | +4.5V to +5.5V |

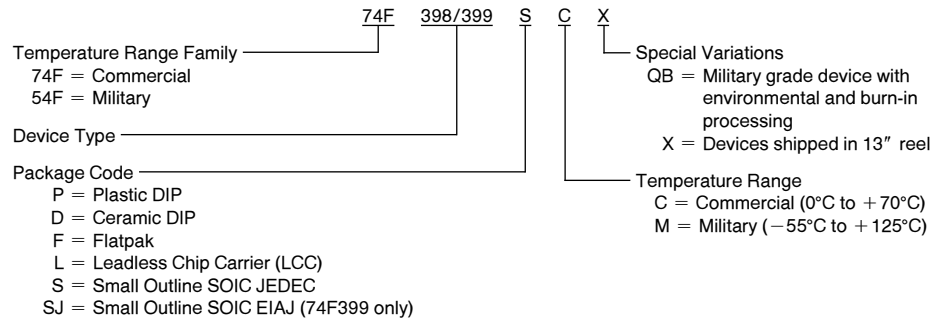
DC Electrical Characteristics

| Symbol | Parameter | 54F/74F | | | Units | V _{CC} | Conditions |
|------------------|-----------------------------------|--|-------------------|-------------|-------|-----------------|---|
| | | Min | Typ | Max | | | |
| V _{IH} | Input HIGH Voltage | 2.0 | | | V | | Recognized as a HIGH Signal |
| V _{IL} | Input LOW Voltage | | | 0.8 | V | | Recognized as a LOW Signal |
| V _{CD} | Input Clamp Diode Voltage | | | -1.2 | V | Min | I _{IN} = -18 mA |
| V _{OH} | Output HIGH Voltage | 54F 10% V _{CC} 74F 10% V _{CC} 74F 5% V _{CC} | 2.5 2.5 2.7 | | V | Min | I _{OH} = -1 mA I _{OH} = -1 mA I _{OH} = -1 mA |
| V _{OL} | Output LOW Voltage | 54F 10% V _{CC} 74F 10% V _{CC} | | 0.5 0.5 | V | Min | I _{OL} = 20 mA I _{OL} = 20 mA |
| I _{IH} | Input HIGH Current | 54F 74F | | 20.0 5.0 | μA | Max | V _{IN} = 2.7V |
| I _{BVI} | Input HIGH Current Breakdown Test | 54F 74F | | 100 7.0 | μA | Max | V _{IN} = 7.0V |
| I _{CEX} | Output HIGH Leakage Current | 54F 74F | | 250 50 | μA | Max | V _{OUT} = V _{CC} |
| V _{ID} | Input Leakage Test | 74F | 4.75 | | V | 0.0 | I _{ID} = 1.9 μA All Other Pins Grounded |
| I _{OD} | Output Leakage Circuit Current | 74F | | 3.75 | μA | 0.0 | V _{IOD} = 150 mV All Other Pins Grounded |
| I _{IL} | Input LOW Current | | | -0.6 | mA | Max | V _{IN} = 0.5V |
| I _{OS} | Output Short-Circuit Current | | | -60 | mA | Max | V _{OUT} = 0V |
| I _{CCH} | Power Supply Current (F398) | | 25 | 38 | mA | Max | V _O = HIGH |
| I _{CCL} | Power Supply Current (F398) | | 25 | 38 | mA | Max | V _O = LOW |
| I _{CCH} | Power Supply Current (F399) | | 22 | 34 | mA | Max | V _O = HIGH |
| I _{CCL} | Power Supply Current (F399) | | 22 | 34 | mA | Max | V _O = LOW |

| AC Electrical Characteristics | | | | | | | | | |
|--------------------------------------|-------------------------|---|-----|--|--|--|--|-------|-------|
| Symbol | Parameter | 74F | | | 54F | | 74F | | Units |
| | | T _A = +25°C V _{CC} = +5.0V C _L = 50 pF | | | T _A , V _{CC} = Mil C _L = 50 pF | | T _A , V _{CC} = Com C _L = 50 pF | | |
| | | Min | Typ | Max | Min | Max | Min | Max | |
| f _{max} | Input Clock Frequency | 100 | 140 | | 80 | | 100 | | MHz |
| t _{PLH} | Propagation Delay | 3.0* | 5.7 | 7.5 | 3.0 | 9.5 | 3.0 | 8.5 | ns |
| t _{PHL} | CP to Q or \bar{Q} | 3.0 | 6.8 | 9.0 | 3.0 | 11.5 | 3.0 | 10.0 | |
| *F398 3.3 ns | | | | | | | | | |
| AC Operating Requirements | | | | | | | | | |
| Symbol | Parameter | 74F | | 54F | | 74F | | Units | |
| | | T _A = +25°C V _{CC} = +5.0V | | T _A , V _{CC} = Mil | | T _A , V _{CC} = Com | | | |
| | | Min | Max | Min | Max | Min | Max | | |
| t _s (H) | Setup Time, HIGH or LOW | 3.0 | | 4.5 | | 3.0 | | ns | |
| t _s (L) | I _n to CP | 3.0 | | 4.5 | | 3.0 | | | |
| t _h (H) | Hold Time, HIGH or LOW | 1.0 | | 1.5 | | 1.0 | | ns | |
| t _h (L) | I _n to CP | 1.0 | | 1.5 | | 1.0 | | | |
| t _s (H) | Setup Time, HIGH or LOW | 7.5 | | 10.5 | | 8.5 | | ns | |
| t _s (L) | S to CP ('F398) | 7.5 | | 10.5 | | 8.5 | | | |
| t _s (H) | Setup Time, HIGH or LOW | 7.5 | | 9.5 | | 8.5 | | | |
| t _s (L) | S to CP ('F399) | 7.5 | | 9.5 | | 8.5 | | | |
| t _h (H) | Hold Time, HIGH or LOW | 0 | | 0 | | 0 | | | |
| t _h (L) | S to CP | 0 | | 0 | | 0 | | | |
| t _w (H) | CP Pulse Width | 4.0 | | 4.0 | | 4.0 | | ns | |
| t _w (L) | HIGH or LOW | 5.0 | | 7.0 | | 5.0 | | | |

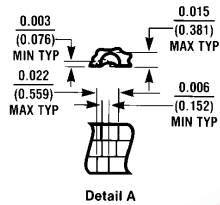
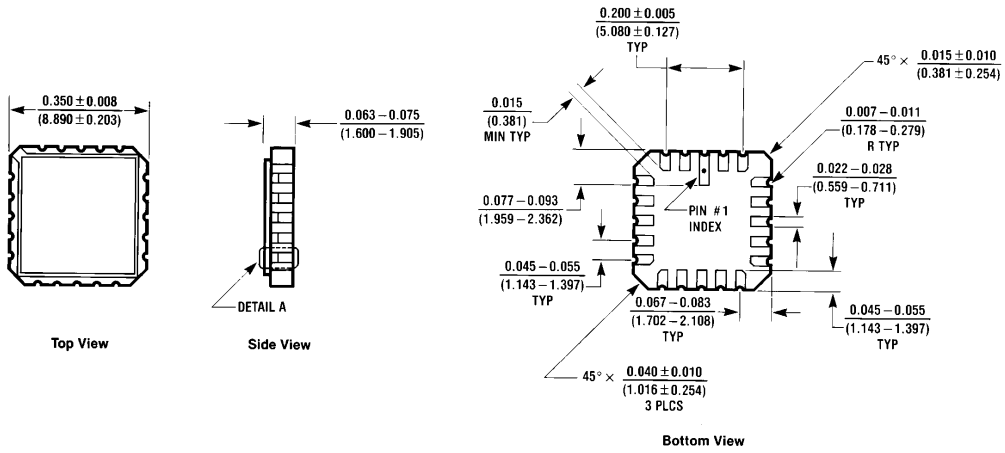
Ordering Information

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:



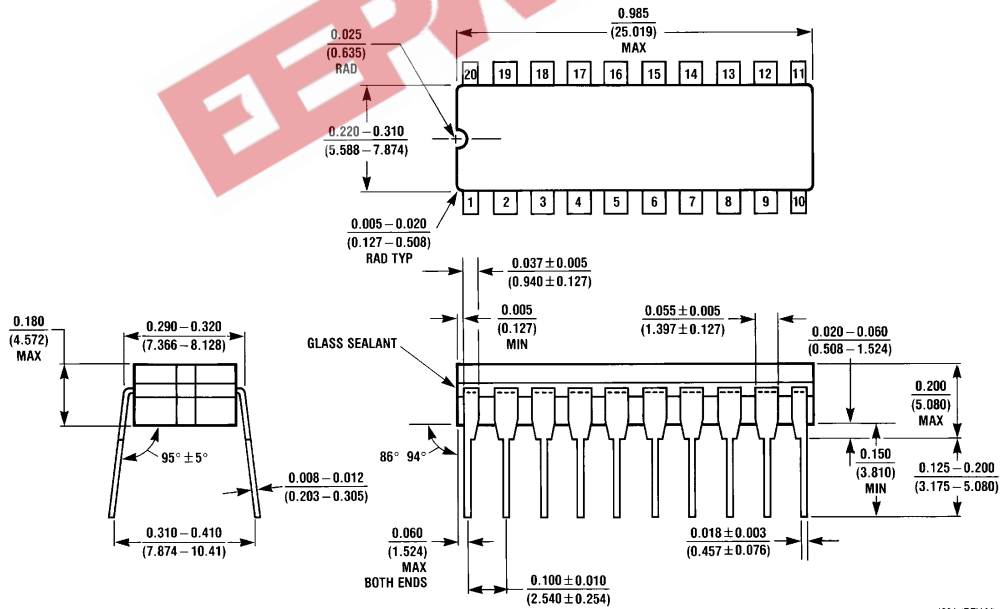
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Physical Dimensions inches (millimeters)



20-Lead Ceramic Leadless Chip Carrier (L)
NS Package Number E20A

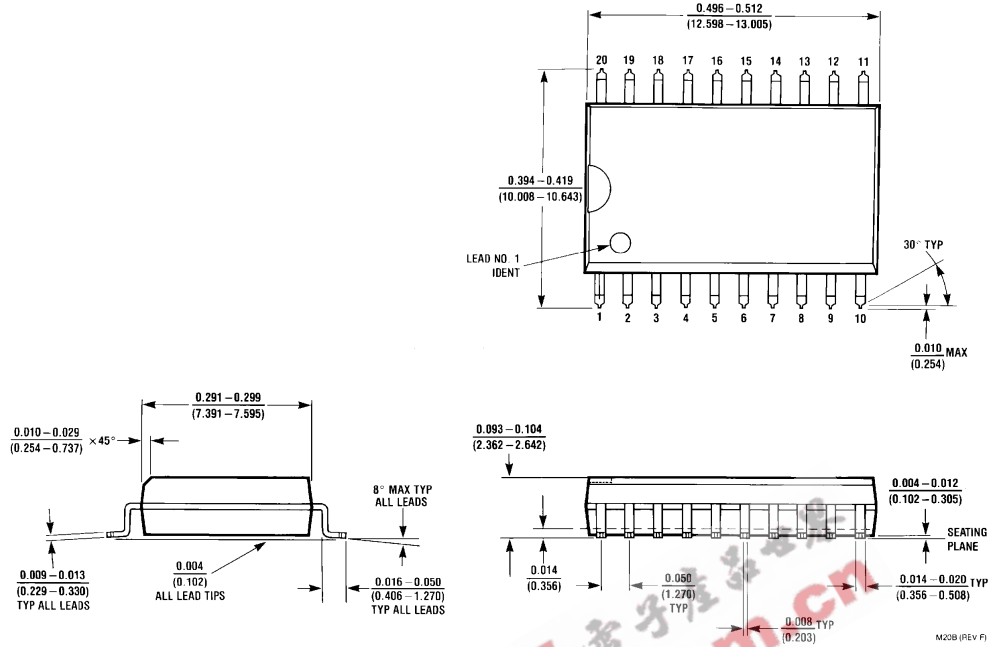
E20A (REV D)



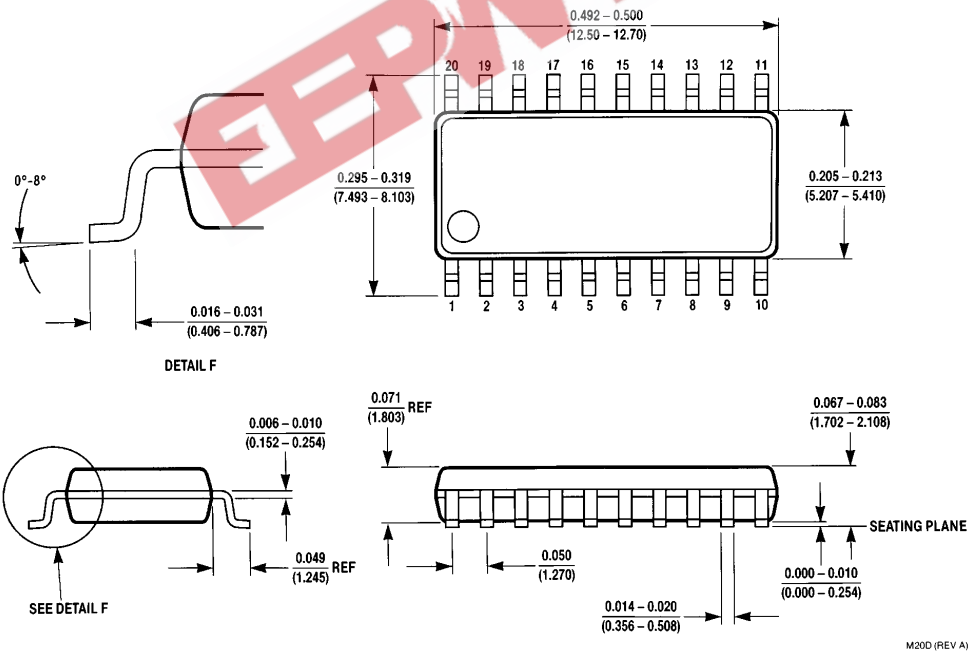
20-Lead Ceramic Dual-In-Line Package (D)
NS Package Number J20A

J20A (REV M)

Physical Dimensions inches (millimeters) (Continued)

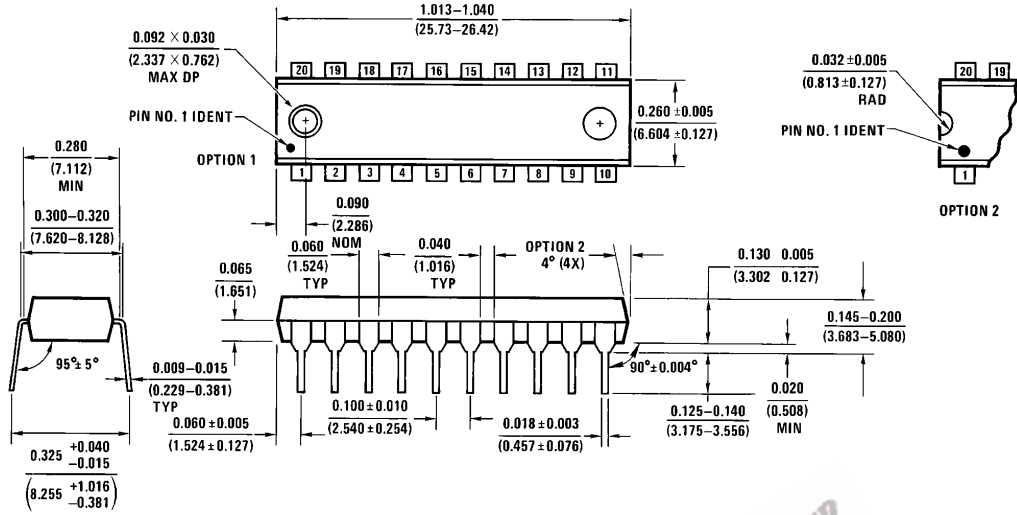


**20-Lead (0.300" Wide) Molded Small Outline Package, JEDEC (S)
NS Package Number M20B**



**20-Lead (0.300" Wide) Molded Small Outline Package, EIAJ (SJ)
NS Package Number M20D**

Physical Dimensions inches (millimeters) (Continued)

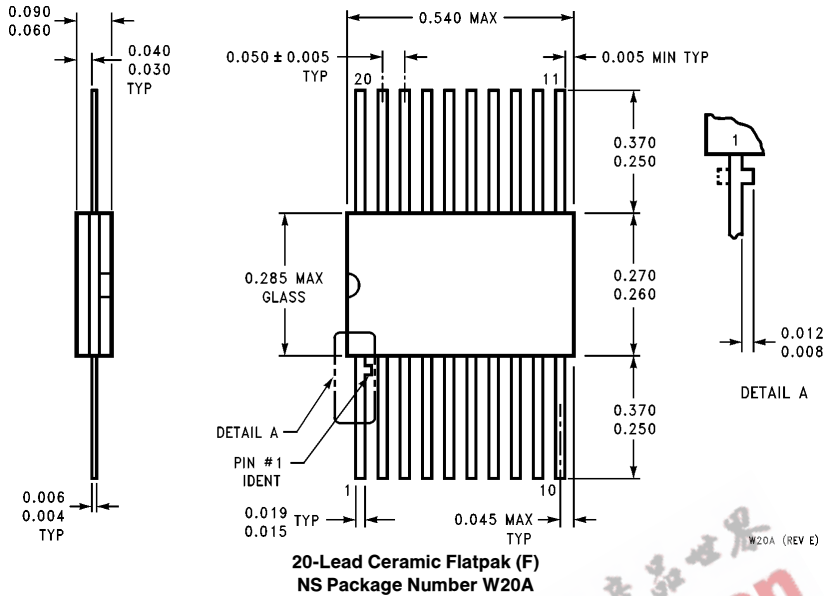


20-Lead (0.300" Wide) Molded Dual-In-Line Package (P)
NS Package Number N20A

N20A (REV G)

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Physical Dimensions inches (millimeters) (Continued)



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